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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Emami, et al.

Serial No.: 09/727,133

Confirmation No.: 2919

Filed: November 29, 2000

For: Planarized Copper Cleaning for
Reduced Defects

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

§ Group Art Unit: 1763
§ Examiner: George A. Goudreau
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CERTIFICATE OF MAILING 37 CFR 1.8	
I hereby certify that this correspondence is being deposited on <u>October 31, 2003</u> , with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Non- Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
<u>10/31/03</u>	<u>Keith Tackett</u>
Date	Signature

STATEMENT OF COMMON OWNERSHIP

The present application (Serial No. 09/727,133; hereinafter the "Application") and U.S. Patent Serial No. 6,436,302 *Li et al.*, were, at the time the invention of the Application was made, owned by the same person, or subject to an obligation of assignment to the same person, Applied Materials, Inc.

Respectfully submitted,


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